

The listing of claims will replace all prior versions, and listings, of claims in the application:

**Listing of Claims:**

1. (Currently Amended) A laminar mat comprising a rigid planar tile of moulded plastics material having on respective faces a planar layer nonadhesively bonded ~~integrated~~ therewith ~~during moulding of the tile~~, the planar layers each being of similar material.

2. (Original) A laminar mat as claimed in claim 1 wherein the planar layers comprise a plastics material.

3. (Original) A laminar mat as claimed in claim 2 wherein said plastics material is polypropylene.

4. (Original) A laminar mat as claimed in claim 3 wherein said plastics material is oriented polypropylene.

5. (Original) A laminar mat as claimed in claim 1 wherein the planar layers comprise paper.

6. (Original) A laminar mat as claimed in claim 1 wherein the planar layers comprise card.

7. (Original) A laminar mat as claimed in claim 1 wherein both of the planar layers are laminated

8. (Original) A laminar mat as claimed in claim 7 wherein the planar layers include at least one laminae selected from the following: plastics material, paper and card.

9. (Original) A laminar mat as claimed in claim 8 wherein the plastics material is selected from polypropylene, oriented polypropylene and polyester.

10. (Original) A laminar mat as claimed in claim 7 wherein the planar layers each comprise three laminae.

11. (Original) A laminar mat as claimed in claim 10 wherein the planar layers each comprise three laminae of oriented polypropylene.

12. (Original) A laminar mat as claimed in claim 10 wherein the planar layers each comprise a lamina of paper provided between laminae of oriented polypropylene.

13-21 (Cancelled).

22. (Previously Amended) A laminar mat as claimed in claim 1 wherein at least one of the planar layers includes a coating which has one of high grip properties, anti-static properties and non-slip properties.

23. (Original) A method as claimed in claim 21, the method further including the steps of:

including on one of said planar layers heat-activated adhesive means on a lamina of heat conductive material;

after removing the moulded tile from the mould, positioning backing material on said layer of the tile using alignment means to align the tile and backing material;

and activating the heat activated adhesive to bond the backing material to the tile.

24. (Previously Amended) A laminar mat as claimed in claim 1 wherein at least one of said planar layers is textured by the mould during moulding.

25. (Cancelled).

26. (Original) A method as claimed in claim 21 including the step of providing alignment means on the tile, said alignment means serving to align the backing material before activation of the adhesive.

27. (Cancelled).

28. (Previously Amended) A laminar mat as claimed in claim 1, the mat including a non-slip backing material attached thereto.

29. (Original) A laminar mat as claimed in claim 28 wherein said non-slip backing material is attached by adhesive.

30. (Original) A laminar mat as claimed in claim 29 wherein said adhesive is a heat activated adhesive.

31. (Original) A laminar mat as claimed in claim 30, wherein the planar layer provided between the tile and the backing material comprises a first lamina fixed to the planar tile, a second lamina of aluminium foil bonded to the opposite side of the first lamina, and a lamina of heat sensitive adhesive fixed to the aluminium foil.

32-42 (Cancelled).